Octal D-type flip-flop with 5 V tolerant inputs/outputs; positive edge-trigger; 3-state

Rev. 5 — 18 December 2012

Product data sheet

1. General description

The 74LVC574A is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. A clock (CP) and an Output Enable (OE) input are common to all flip-flops.

The eight flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW to HIGH CP transition.

When \overline{OE} is LOW, the contents of the eight flip-flops are available at the outputs. When \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of the \overline{OE} input does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V or 5 V applications.

The 74LVC574A is functionally identical to the 74LVC374A, but has a different pin arrangement.

2. Features and benefits

- 5 V tolerant inputs for interfacing with 5 V logic
- Supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- 8-bit positive edge-triggered register
- Independent register and 3-state buffer operation
- Flow-through pin-out architecture
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

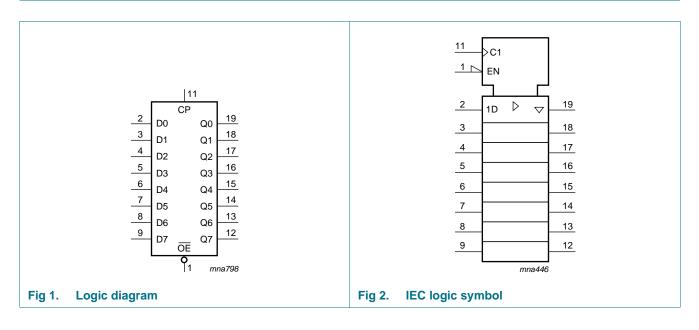


Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

3. Ordering information

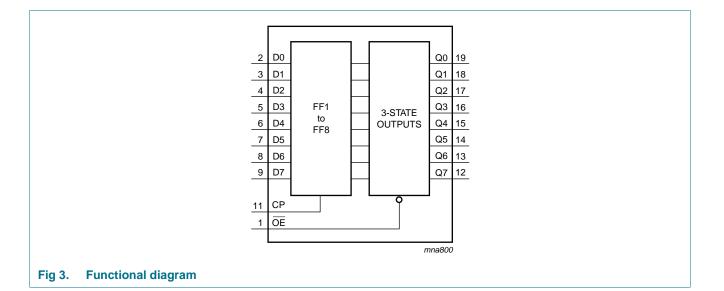
Type number	Package								
	Temperature range	Name	Description	Version					
74LVC574AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
74LVC574ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1					
74LVC574APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					
74LVC574ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1					

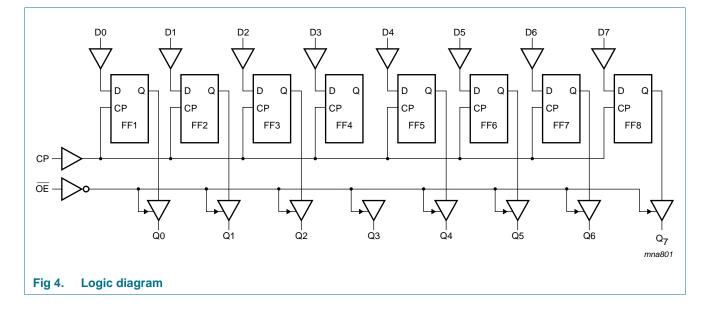
4. Functional diagram



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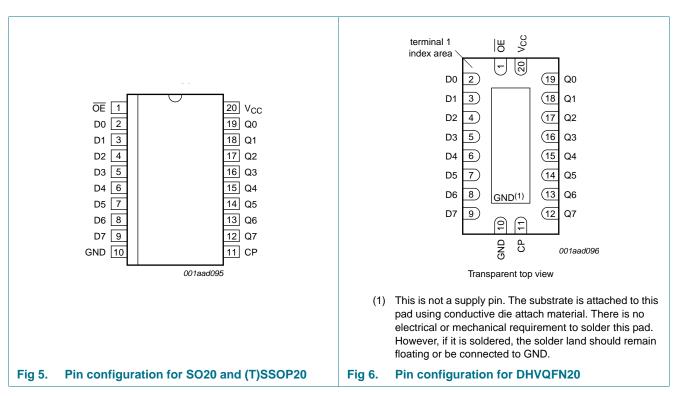
Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state





Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

5. Pinning information



5.1 Pinning

5.2 Pin description

Symbol	Pin	Description
Cymbol		Description
OE	1	output enable input (active LOW)
СР	11	clock input (LOW to HIGH; edge triggered)
D[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input
Q[0:7]	19, 18, 17, 16, 15, 14, 13, 12	data output
GND	10	ground (0 V)
V _{CC}	20	supply voltage

Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

6. Functional description

Table 3.Functional table^[1]

Operating modes	Input		Internal	Output	
	OE	СР	Dn	flip-flop	Qn
Load and read register	L	^	I	L	L
	L	↑	h	Н	Н
Load register and disable outputs	Н	↑	I	L	Z
	Н	↑	h	Н	Z

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the LOW to HIGH CP transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the LOW to HIGH CP transition

 \uparrow = LOW to HIGH clock transition

Z = high-impedance OFF-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0	-	±50	mA
Vo	output voltage	output HIGH or LOW state	<u>[2]</u> –0.5	V _{CC} + 0.5	V
Ι _Ο	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	<u>[3]</u>	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.

For (T)SSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

8. Recommended operating conditions

Table 5.	Recommended operating condition	tions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	–40 °C to	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{\text{CC}}$	-	-	$0.65 \times V_{\text{CC}}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
	V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
VIL	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35\times V_{CC}$	V
	V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{он}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		I_{O} = -8 mA; V_{CC} = 2.3 V	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; $V_{\rm I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

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Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V}; \\ V_{O} = 5.5 \text{ V or GND};$	-	0.1	±10	-	±20	μA
I _{OFF}	power-off leakage supply	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	0.1	±10	-	±20	μA
I _{CC}	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μA
ΔI_{CC}	additional supply current	per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} – 0.6 V; I _O = 0 A	-	5	500	-	5000	μA
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_I = GND$ to V_{CC}	-	5.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7.Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	–40 °C to +85 °C			–40 °C to +125 °C	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	-
t _{pd}	propagation	CP to Qn; see Figure 7	[2]						
	delay	$V_{CC} = 1.2 V$		-	17.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		4.6	6.4	13.1	4.6	15.1	ns
		V_{CC} = 2.3 V to 2.7 V		2.6	3.9	7.9	2.6	9.1	ns
	$V_{CC} = 2.7 V$		1.5	3.7	8.0	1.5	10.0	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.5	7.0	1.5	9.0	ns
t _{en} e	enable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	19.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	7.0	17.1	1.5	19.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.0	9.4	1.5	10.9	ns
		$V_{CC} = 2.7 V$		1.5	4.1	8.5	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.2	7.5	1.5	9.5	ns
t _{dis}	disable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	9.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.5	4.1	10.1	2.5	11.6	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.3	5.7	1.0	6.6	ns
		$V_{CC} = 2.7 V$		1.5	3.1	6.5	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	2.9	6.0	1.5	7.5	ns

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Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
			-	Min	Typ <mark>[1]</mark>	Max	Min	Max	-
t _W	pulse width	clock HIGH or LOW; see Figure 7			I	I			
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.3	-	-	3.3	-	ns
		V_{CC} = 3.0 V to 3.6 V		3.3	1.7	-	3.3	-	ns
t _{su}	set-up time	Dn to CP; see Figure 8							
		V_{CC} = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		V_{CC} = 3.0 V to 3.6 V		2.0	0.3	-	2.0	-	ns
t _h	hold time	Dn to CP; see Figure 8							
		V_{CC} = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.5	-	-	1.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		+1.5	-0.2	-	+1.5	-	ns
f _{max}	maximum	see Figure 7							
	frequency	V_{CC} = 1.65 V to 1.95 V		100	-	-	80	-	MHz
		V_{CC} = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	200	-	120	-	MHz
t _{sk(0)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per flip-flop; $V_I = GND$ to V_{CC}	[4]						
	capacitance	V_{CC} = 1.65 V to 1.95 V		-	11.2	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V		-	13.2	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	14.9	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 10</u>.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZL} and $t_{\text{PZH}}.$

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

 V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

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11. AC waveforms

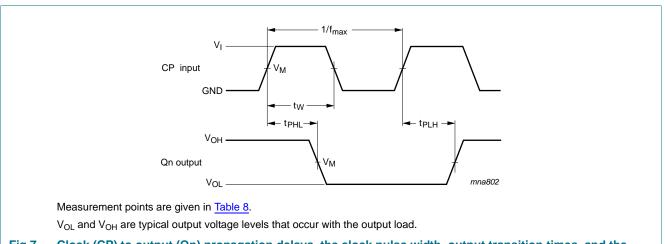
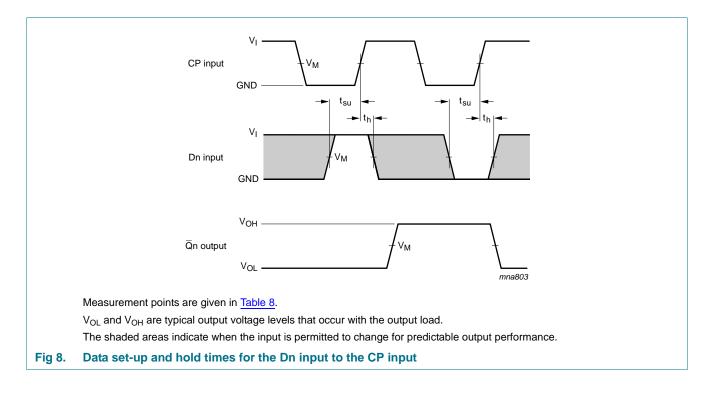


Fig 7. Clock (CP) to output (Qn) propagation delays, the clock pulse width, output transition times, and the maximum frequency



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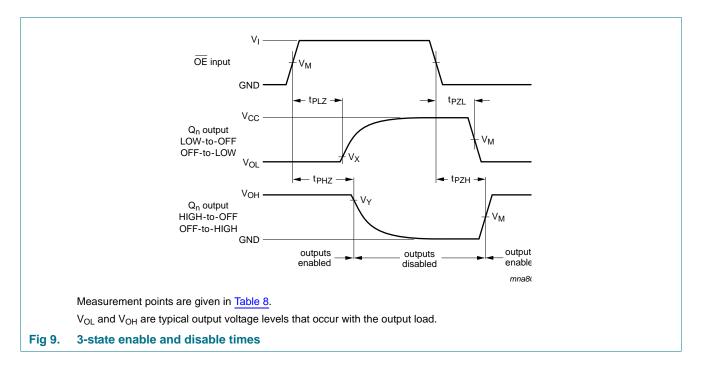


Table 8. Measurement points

Supply voltage	Input		Output			
V _{cc}	VI	V _M	V _M	V _X	V _Y	
1.2 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$	
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
2.3 V to 2.7 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V	

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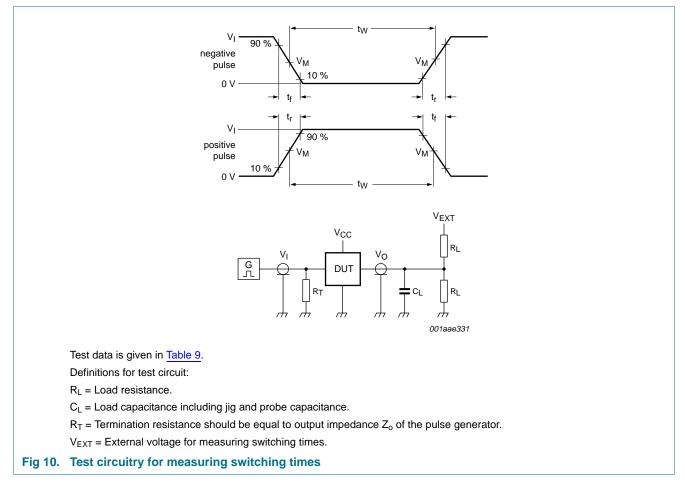


Table 9. Test dat	а							
Supply voltage	Input	Input			V _{EXT}	V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	

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Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

12. Package outline

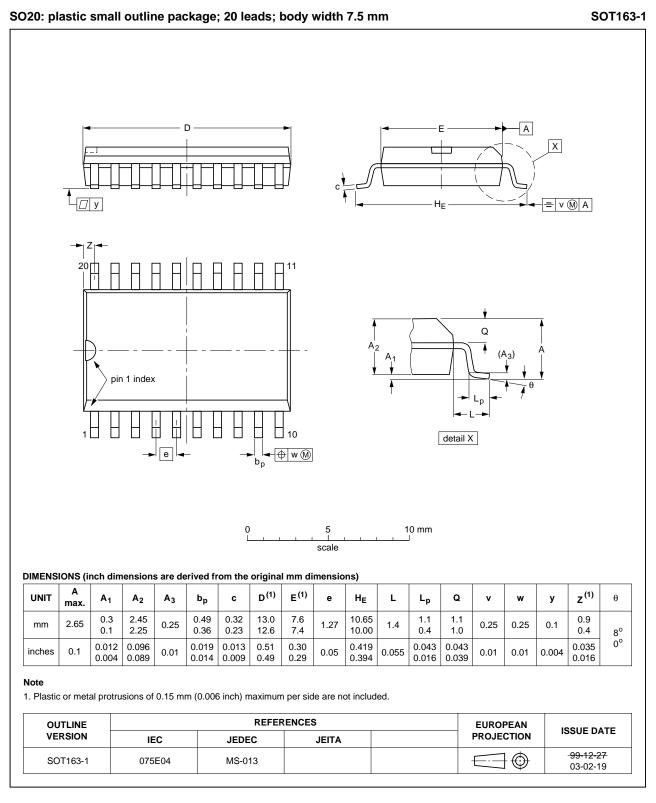


Fig 11. Package outline SOT163-1 (SO20)

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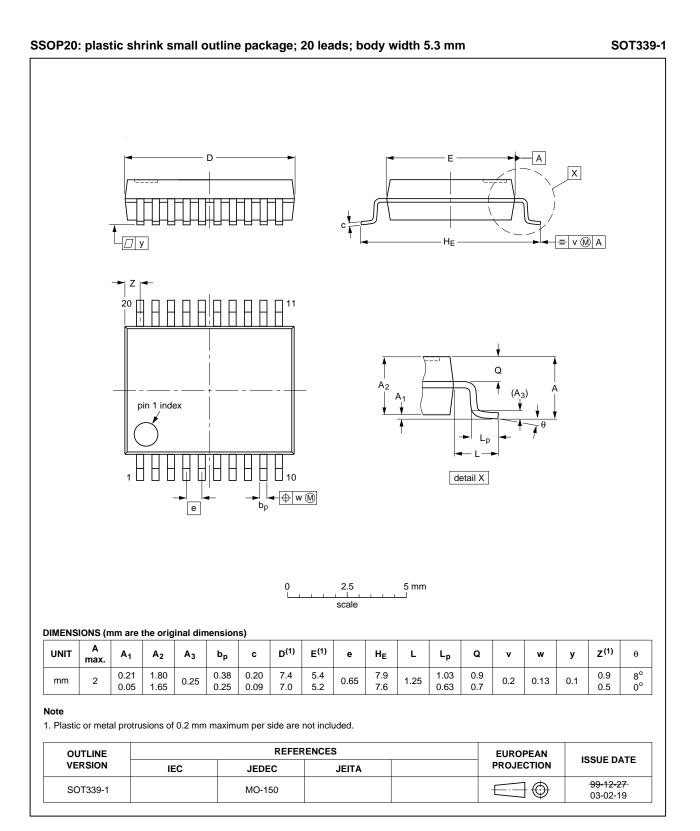


Fig 12. Package outline SOT339-1 (SSOP20)

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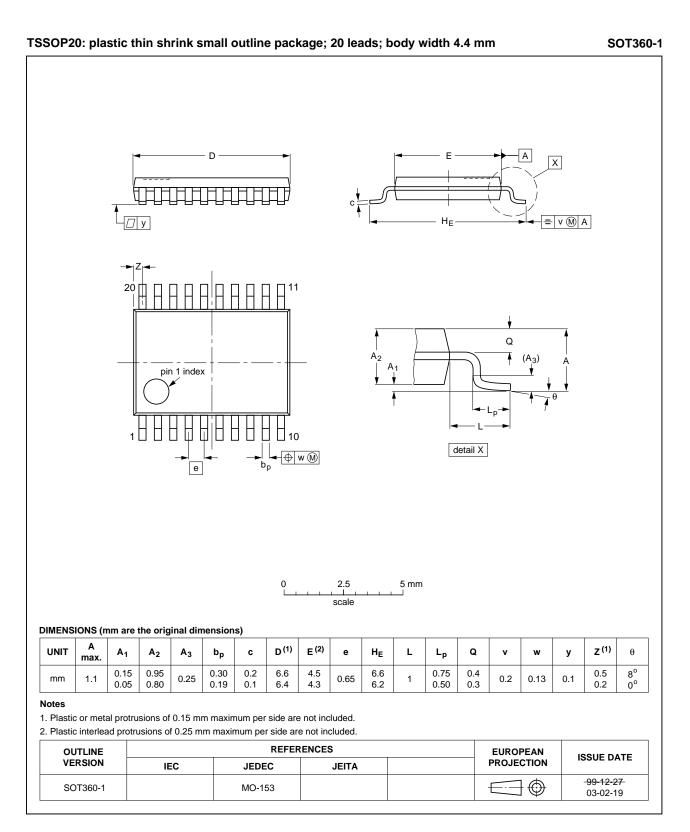
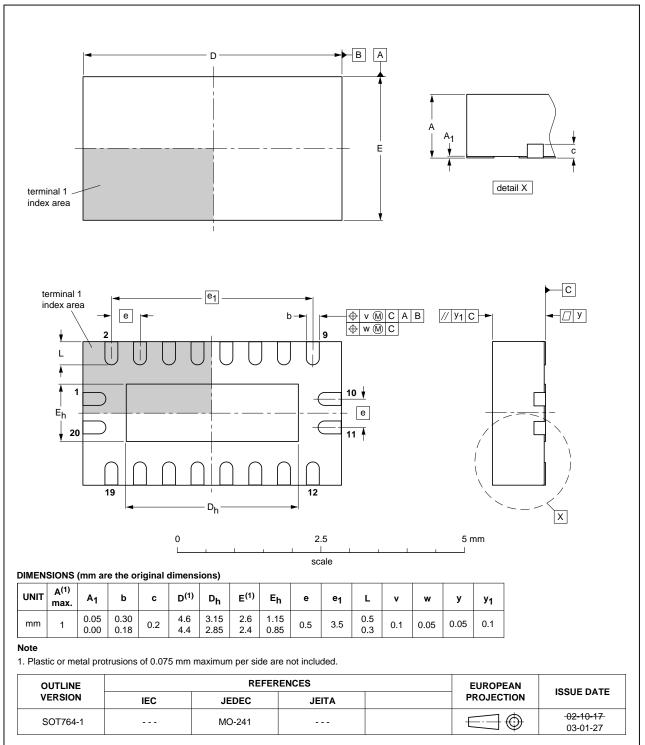


Fig 13. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 14. Package outline SOT764-1 (DHVQFN20)

Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

13. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision	history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC574A v.5	20121218	Product data sheet	-	74LVC574A v.4	
Modifications:	 Changed inter 	lacing into interfacing (errata	a) in features list.		
74LVC574A v.4	20121203	Product data sheet	-	74LVC574A v.3	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts have been adapted to the new company name where appropriate. 				
	• Table 4, Table 5, Table 6, Table 7, Table 8 and Table 9: values added for lower voltage ranges				
74LVC574A v.3	20040322	Product specification	-	74LVC574A v.2	
74LVC574A v.2	20030620	Product specification	-	74LVC574A v.1	
74LVC574A v.1	19980729	Product specification	-	-	

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Octal D-type flip-flop; 5 V tolerance; positive edge-trigger; 3-state

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